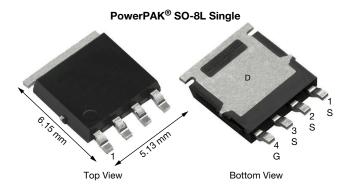
SQJA61EP

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Automotive P-Channel 60 V (D-S) 175 °C MOSFET



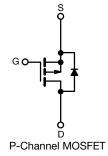
PRODUCT SUMMARY				
V _{DS} (V)	-60			
$R_{DS(on)} (\Omega)$ at $V_{GS} = -10 V$	0.0121			
$R_{DS(on)} (\Omega)$ at $V_{GS} = -4.5 \text{ V}$	0.0225			
I _D (A)	-54.5			
Configuration	Single			
Package	PowerPAK SO-8L			

FEATURES

- TrenchFET[®] power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



ROHS COMPLIANT HALOGEN FREE



ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	-60	V	
Gate-source voltage		V _{GS}	± 20	v	
Continuous drain current	T _C = 25 °C	I	-54.5		
	T _C = 125 °C	ID	-33.2		
Continuous source current (diode conduction)		I _S	-62	A	
Pulsed drain current ^a		I _{DM}	-180		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	-44		
Single pulse avalanche energy		E _{AS}	96.8	mJ	
Maximum power dissipation	T _C = 25 °C	р	68	w	
	T _C = 125 °C	P _D	22		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C	
Soldering recommendations (peak temperature) ^c			260	C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction to ambient	PCB mount ^b	R _{thJA}	68	°C/W	
Junction to case (drain)		R _{thJC}	2.2	0/10	

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. When mounted on 1" square PCB (FR4 material)

c. See solder profile (<u>www.vishay.com/doc?73257</u>). For PowerPAK SO-8L, the end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•					
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0, I_D = -250 \ \mu A$		-60	-	-	v
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	V _{DS} = V _{GS} , I _D = -250 μA		-2.0	-2.5	v
Gate-source leakage	I _{GSS}	V _{DS} =	$0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA
		$V_{GS} = 0 V$	V _{GS} = 0 V V _{DS} = -60 V		-	-10	
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$	$V_{DS} = -60 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	-50	μA
		$V_{GS} = 0 V$	V _{DS} = -60 V, T _J = 175 °C	-	-	-250	
On-state drain current ^a	I _{D(on)}	V _{GS} = -10 V	$V_{DS} \le -5 V$	-15	-	-	Α
		V _{GS} = -10 V	I _D = -10 A	-	0.0100	0.0121	
Durin an un state un interne 3	D	V _{GS} = -10 V	I _D = -10 A, T _J = 125 °C	-	-	0.0174	0
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = -10 V	I _D = -10 A, T _J = 175 °C	-	-	0.0204	Ω
		$V_{GS} = -4.5 V$	I _D = -6 A	-	0.0168	0.0225	
Forward transconductance ^b	g fs	V _{DS} =	= -15 V, I _D = -10 A	-	32	-	S
Dynamic ^b							
Input capacitance	Ciss		V _{DS} = -25 V, f = 1 MHz	-	3246	4800	pF
Output capacitance	Coss	$V_{GS} = 0 V$		-	1798	2800	
Reverse transfer capacitance	C _{rss}	1		-	88	132	
Total gate charge ^c	Qg		0 V V _{DS} = -30 V, I _D = -10 A		48	75	nC
Gate-source charge ^c	Q _{gs}	V _{GS} = -10 V			13	-	
Gate-drain charge ^c	Q _{gd}	1		-	6.3	-	
Gate resistance	R _g	f = 1 MHz		0.4	0.8	1.2	Ω
Turn-on delay time ^c	t _{d(on)}	$V_{DD} = -30 \text{ V}, \text{ R}_L = 3 \Omega,$ $I_D \cong -10 \text{ A}, \text{ V}_{\text{GEN}} = -10 \text{ V}, \text{ R}_g = 1 \Omega$		-	16	25	ns
Rise time ^c	t _r			-	5	10	
Turn-off delay time ^c	t _{d(off)}			-	31	55	
Fall time ^c	t _f			-	7	12	
Source-Drain Diode Ratings and Character	eristics ^b	·			•		
Pulsed current ^a	I _{SM}				-	-180	А
Forward voltage	V _{SD}	I _F = -10 A, V _{GS} = 0		-	-0.81	-1.2	V
Body diode reverse recovery time	t _{rr}	I _F = -10 A, di/dt = 100 A/μs		-	50	100	ns
Body diode reverse recovery charge	Q _{rr}			-	49	100	nC
Reverse recovery fall time	ta			-	21	-	
Reverse recovery rise time	t _b			-	29	-	ns
Body diode peak reverse recovery current	I _{RM(REC)}			-	-1.75	-	Α

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

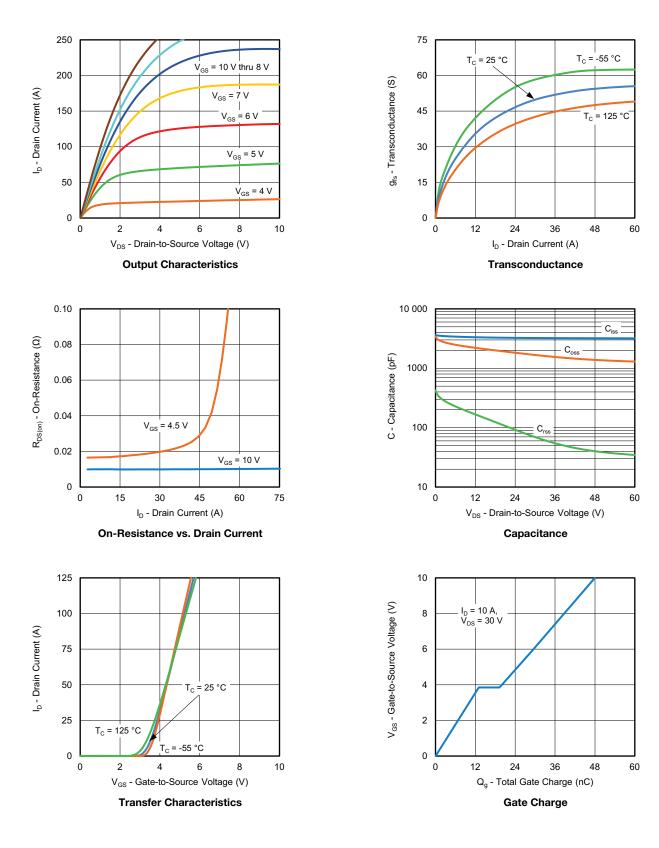
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2



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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



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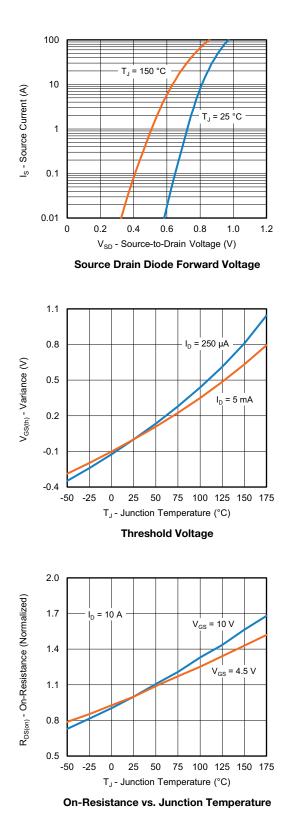
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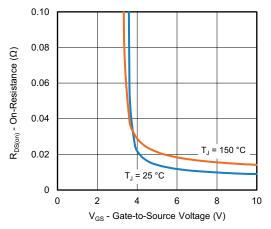
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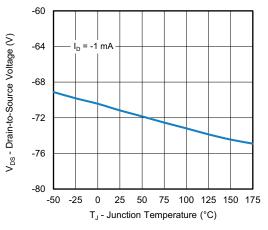
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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

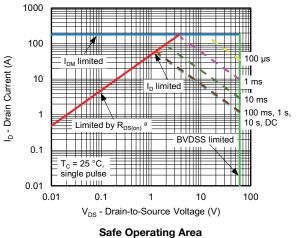


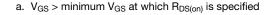


On-Resistance vs. Gate-to-Source Voltage



Drain Source Breakdown vs. Junction Temperature





4 For technical questions, contact: automostech

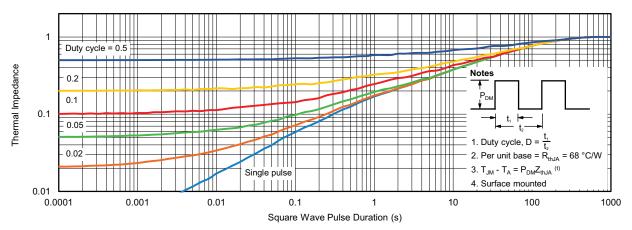
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Note

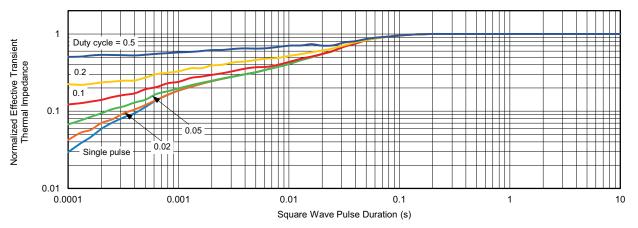


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THERMAL RATINGS (T_C = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Note

• The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?77266.

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